



DIPLOMA IN MOBILE PHONE REPAIRING (DMPR)

DURATION:	3 MONTHS
TOTAL COURSE FEES:	4987/-
ADMISSION FEES:	1990/-
INSTALLMENT:	$999 \times 3(\text{Months})=2997/-$



Course Content

DMIPR

- Introduction of Basic Electronics.
- Mobile Components Identification &
- Mobile Phone components working.
- Uses of Multimeter. * Mobile Components
- Testing & Checking Practical Testing of Components by Multimeter.
- Introduction of Mobile Phone Technology.
- Type of Mobile Phone Technology.
- Working principle of Mobile Phone.
- Feature of Mobile Phone. (Bluetooth, G.P.R.S. Infrared, etc.)
- Removing Software Problem by Codes
- Unlocking codes for G.5.M.Mobile.

Course Content

DMIPR

- Unlocking codes for C.D.M.A. Mobile. * Multimedia Set formatting
- Codes (For virus removing problems). Chinese Mobile Phone Codes.
- Soldering Soldering & Proper use of Micro Iron ,SMD Rework Machine, Hpt Airgun, Etc.
- Desoldering Practice. "* Chip Component Removing & Replacing Jumper
- Practice. (Antenna Switch Jumper, Track Breakage * Jumper, Display Cont Jumper etc)
- Driver IC Jumper Practice. (SIM IC Jumper, Keypad IC Jumper, Display IC Jumper etc,)
- B.G.A. IC Removing, Reballing & Replacing Practice. * 23. Driver IC Changing
- practice * Display Changing Practice (Patta Displays) Ribbon & Patta changing
- Practice. P.F.O. Changing. Pasted B.G.A. IC Removing Practice. Jack Changing
- Practice (Sim Jack. Charging Jack, Hand free Flap Jack, Battery sliding Connector). Phone assembling
- Bluetooth Module Changing Practice.